

## Features

- Split Gate Trench MOSFET Technology
- Excellent Package for Heat Dissipation
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device <sup>(Note 1)</sup>
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

## N-CHANNEL MOSFET

## Maximum Ratings

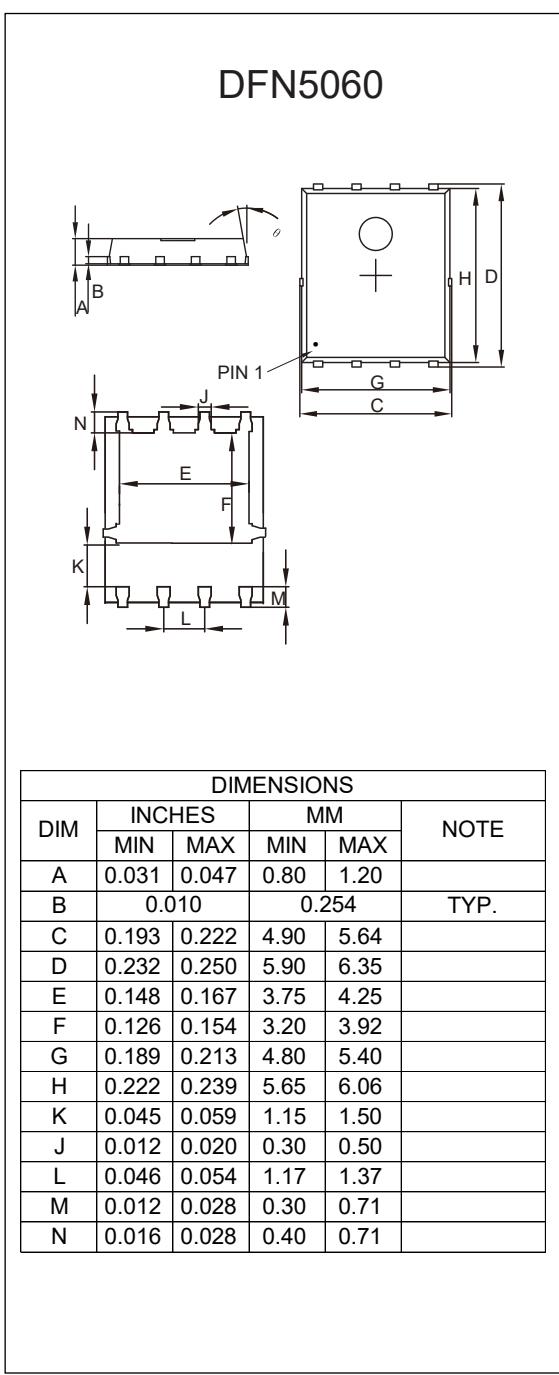
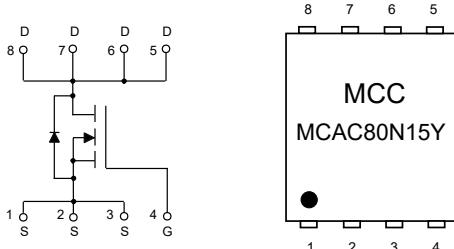
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 50°C/W Junction to Ambient <sup>(Note 2)</sup>
- Thermal Resistance: 0.7°C/W Junction to Case

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	150	V
Gate-Source Voltage	V <sub>GS</sub>	±25	V
Continuous Drain Current T <sub>C</sub> =25°C	I <sub>D</sub>	80	A
T <sub>C</sub> =100°C		50	
Pulsed Drain Current <sup>(Note 3)</sup>	I <sub>DM</sub>	320	A
Total Power Dissipation <sup>(Note 4)</sup>	P <sub>D</sub>	178	W
Single Pulsed Avalanche Energy <sup>(Note 5)</sup>	E <sub>AS</sub>	144	mJ

Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of R<sub>θJA</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub>=25°C.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P<sub>D</sub> is based on max. junction temperature, using junction-case thermal resistance.
5. T<sub>J</sub>=25°C, V<sub>DD</sub>=80V, V<sub>G</sub>=10V, L=1mH.

## Internal Structure and Marking Code



**Electrical Characteristics @ 25°C (Unless Otherwise Specified)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	150			V
Gate-Source Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS} = \pm 25V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=150V, V_{GS}=0V$			1	$\mu A$
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	2.8	4	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$		9.5	11	$m\Omega$
		$V_{GS}=6V, I_D=20A$		11	13	
Gate Resistance	$R_g$	f=1 MHz, Open drain		1.5		$\Omega$
<b>Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$				80	A
Body Diode Voltage	$V_{SD}$	$I_S=20A, V_{GS}=0V$			1.3	V
Reverse Recovery Time	$t_{rr}$	$I_F=20A$ di/dt=100A/ $\mu s$		93		ns
Reverse Recovery Charge	$Q_{rr}$			367		nC
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=75V, V_{GS}=0V, f=1MHz$		5244		$pF$
Output Capacitance	$C_{oss}$			317		
Reverse Transfer Capacitance	$C_{rss}$			10		
Total Gate Charge	$Q_g$	$V_{DD}=75V, I_D=20A$ $V_{GS}=10V$		91		$nC$
Gate-Source Charge	$Q_{gs}$			27		
Gate-Drain Charge	$Q_{gd}$			21		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=75V, V_{GS}=10V, I_D=20A,$ $R_G=3.9\Omega$		18		$ns$
Turn-On Rise Time	$t_r$			39		
Turn-Off Delay Time	$t_{d(off)}$			59		
Turn-Off Fall Time	$t_f$			28		

## Curve Characteristics

Fig. 1 - Typical Output Characteristics

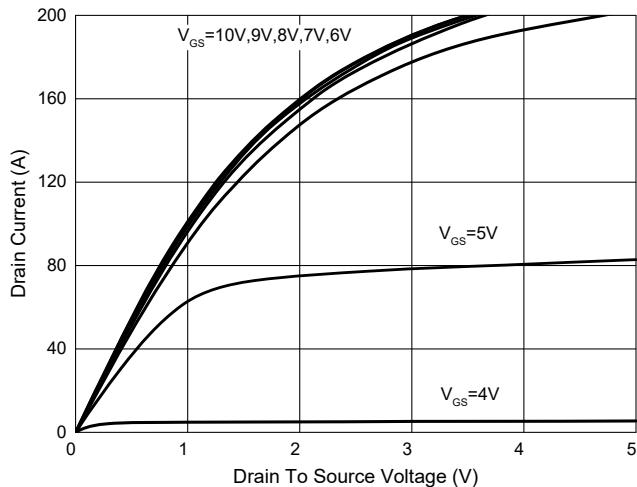


Fig. 2 - Transfer Characteristics

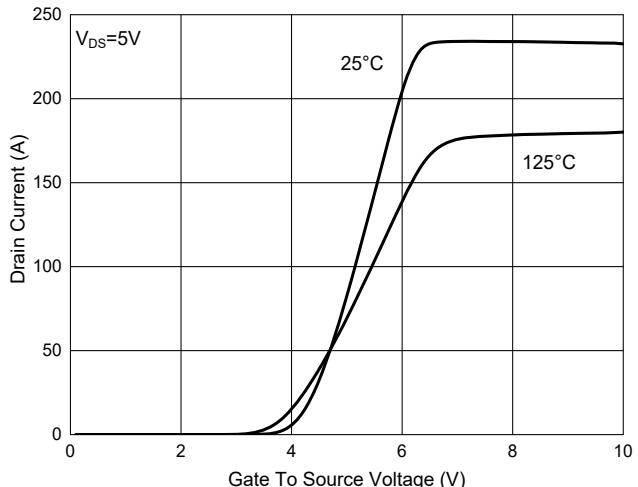


Fig. 3 -  $R_{DS(ON)}$ — $V_{GS}$

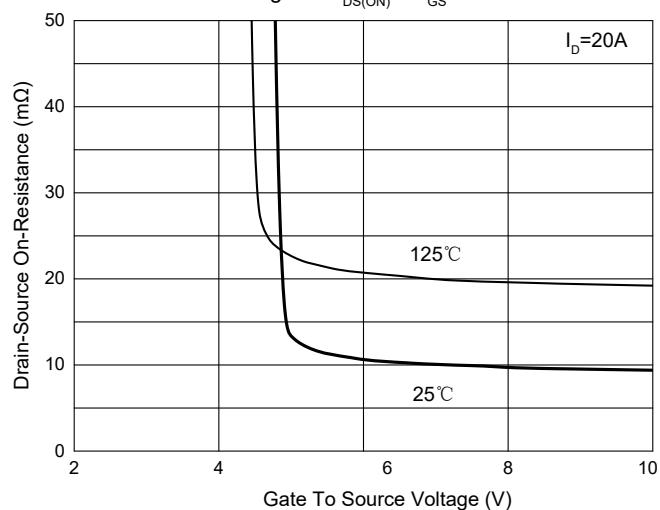


Fig. 4 -  $R_{DS(ON)}$ — $I_D$

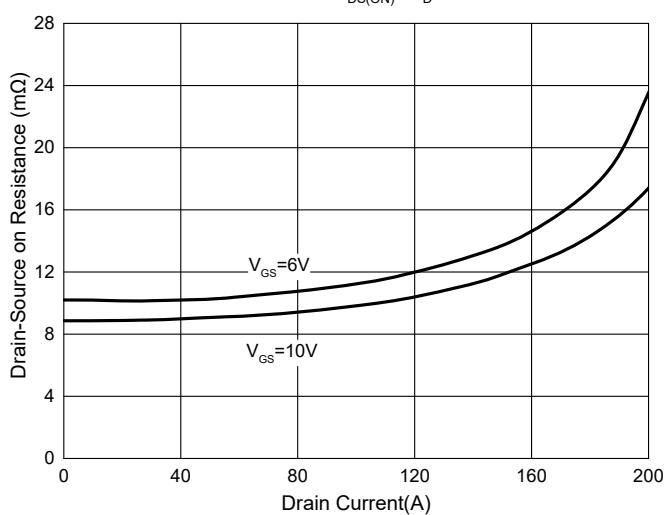


Fig. 5 - Capacitance Characteristics

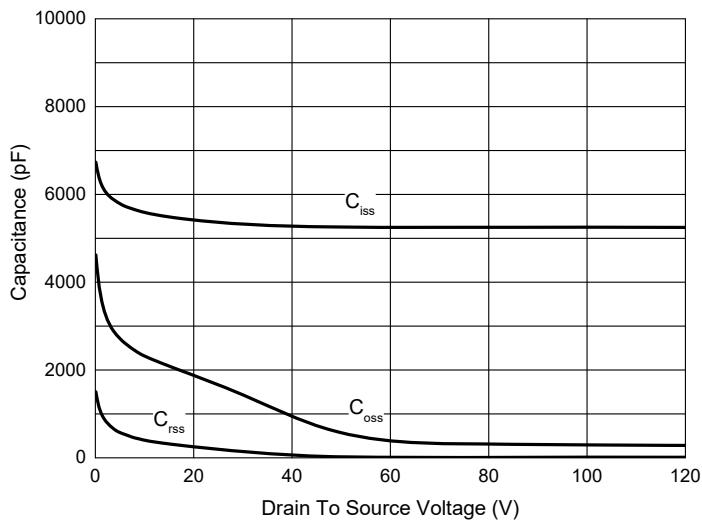
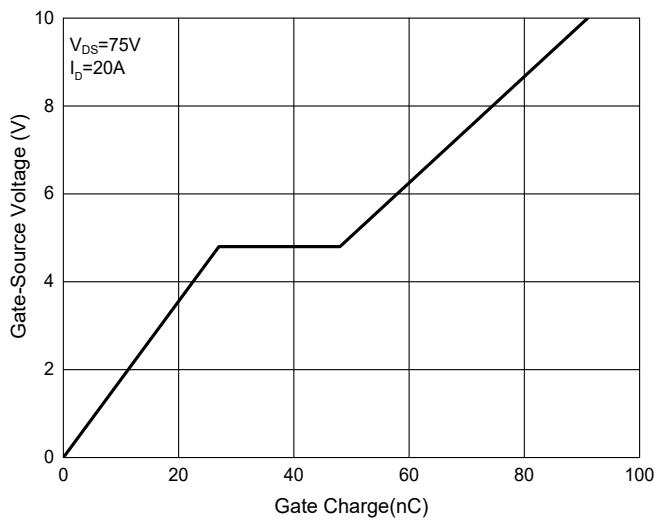


Fig. 6 - Gate Charge



## Curve Characteristics

Fig. 7 - Normalized Threshold voltage

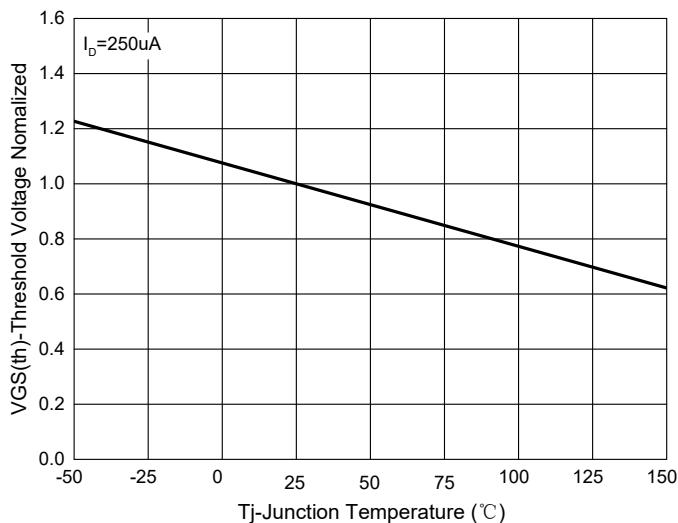


Fig. 8 - Normalized On Resistance Characteristics

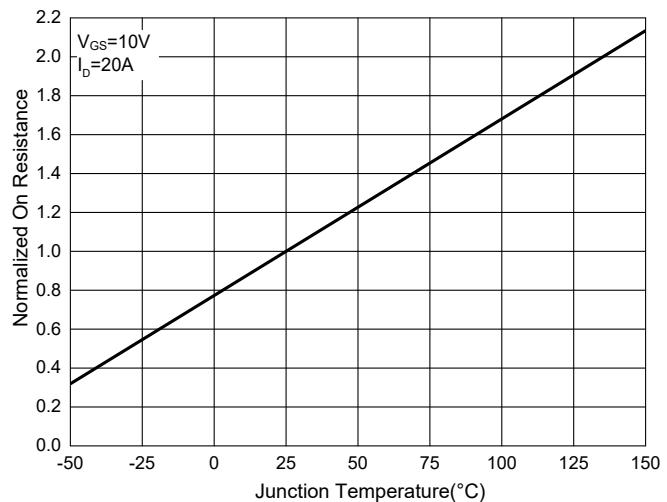


Fig. 9 -  $I_S - V_{SD}$

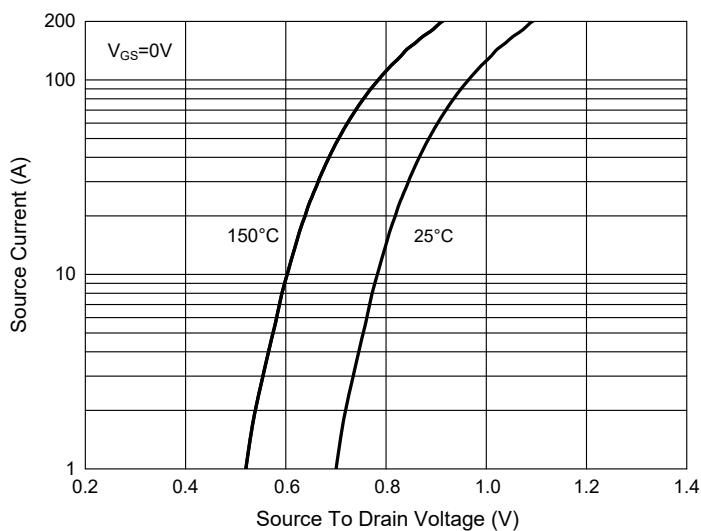


Fig. 10 - Drain Current

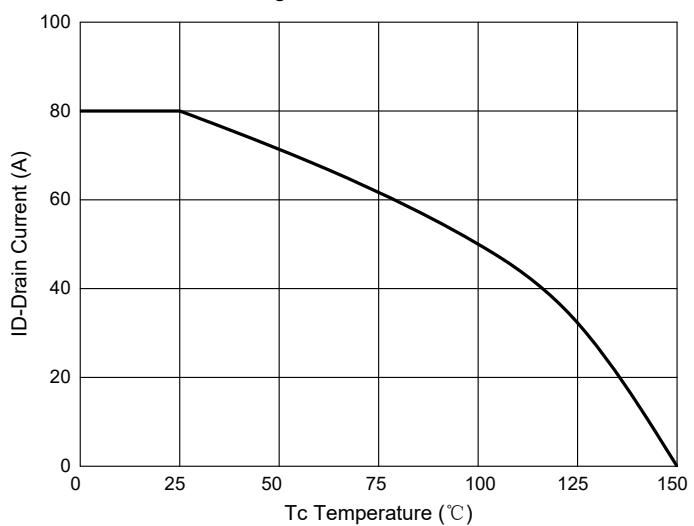
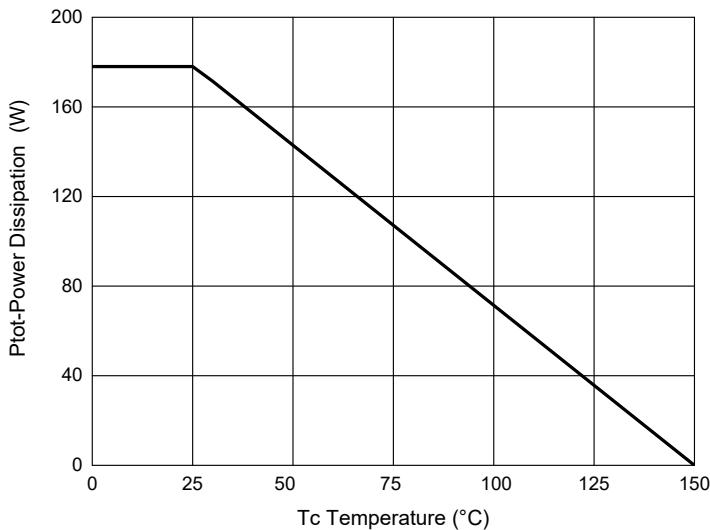


Fig. 11-PD Dissipation



## Curve Characteristics

Fig. 12 - Safe Operation Area

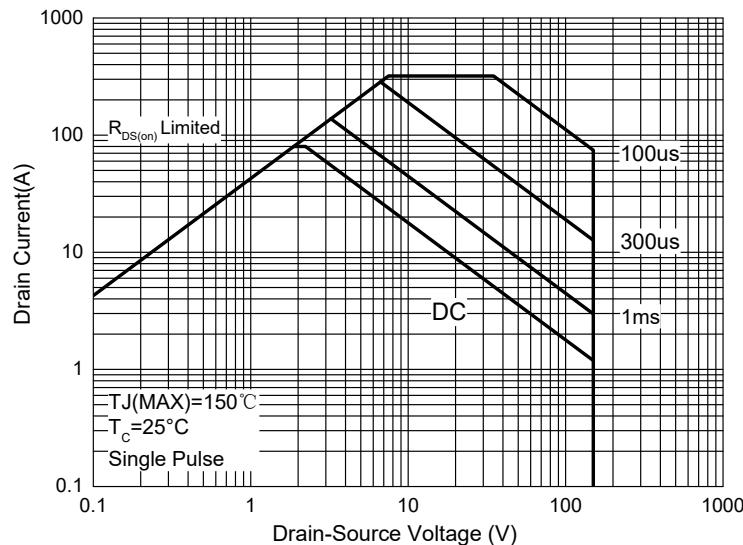
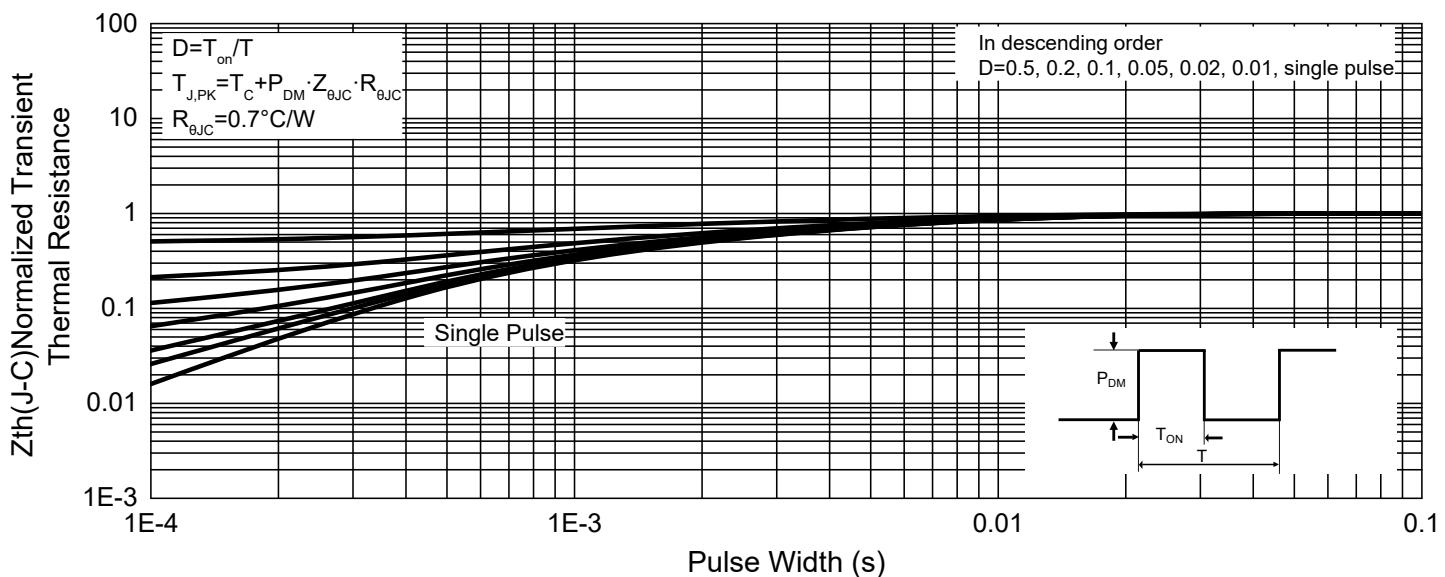


Fig. 13 - Normalized Transient Thermal Impedance



## Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 5Kpcs/Reel

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